





# ULTRA LOW CAPACITANCE TVS ARRAY

## APPLICATIONS

- ✔ Ethernet 10/100/1000 Base T
- ✓ Cellular Phones
- ✓ Audio/Video Inputs
- ✓ Personal Digital Assistant (PDA)

## IEC COMPATIBILITY (EN61000-4)

- ✔ 61000-4-2 (ESD): Air 15kV, Contact 8kV
- ✔ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20µs Level 2(Line-Ground) & Level 3(Line-Line)



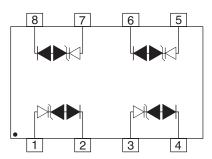
### FEATURES

- ✓ 600 Watts Peak Pulse Power per Line (tp = 8/20µs)
- ✔ Provides Protection For Two Line Pairs
- ✓ ESD Protection > 40 kilovolts
- ✓ LOW LEAKAGE CURRENT < 1.0µA
- ✔ ULTRA LOW CAPACITANCE: 3pF Typical

## **MECHANICAL CHARACTERISTICS**

- ✔ Molded JEDEC SO-8
- ✔ Weight 0.6 grams (Approximate)
- ✔ Flammability rating UL 94V-0
- ✓ 12mm Tape and Reel Per EIA Standard 481
- ✔ Device Marking: Marking Code, Logo, Date Code & Pin One Defined By DOT on Package

### **PINCONFIGURATION**



# **SLVU2.8-4**

# DEVICE CHARACTERISTICS

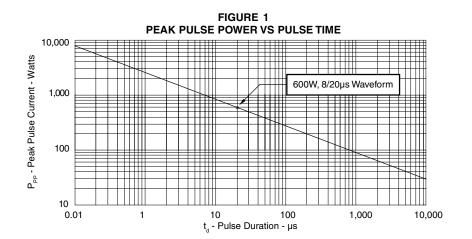
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified									
PARAMETER	SYMBOL	VALUE	UNITS						
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	P <sub>PP</sub>	600	Watts						
Peak Pulse Current ( $t_p = 8/20\mu s$ )	ا <sub>PP</sub>	I <sub>PP</sub> 30							
Lead Soldering Temperature	I <sub>FRM</sub>	260°C (10s)	°C						
Operating Temperature	TJ	-55°C to 150°C	°C						
Storage Temperature	T <sub>STG</sub>	-55°C to 150°C	℃						

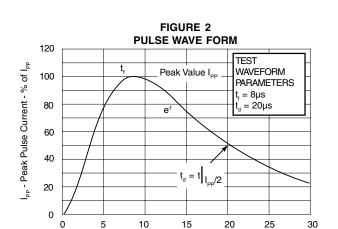
ELECT	ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified										
PART NUMBER	DEVICE MARKING CODE	RATED STAND-OFF VOLTAGE (See Note 1)	MINIMUM BREAKDOWN VOLTAGE (See Note 1)	MINIMUM SNAPBACK VOLTAGE (See Note 1)	MAXIMUM CLAMPING VOLTAGE (See Note 1) (See Fig. 2)	MAXIMUM LEAKAGE CURRENT (See Note 1)	TYPICAL CAPACITANCE (See Note 1)				
		V <sub>MM</sub> VOLTS	@ 1mA V <sub>(BR)</sub> VOLTS	@I <sub>SB</sub> = 50mA V <sub>SB</sub> VOLTS	@I <sub>P</sub> =2A V <sub>C</sub> VOLTS	@I <sub>P</sub> =5A V <sub>C</sub> VOLTS	@I <sub>P</sub> =24A V <sub>C</sub> VOLTS	@I <sub>P</sub> =30A V <sub>C</sub> VOLTS	@V <sub>\MM</sub> Ι <sub>D</sub> μΑ	@0V, 1MHz C pF	
SLVU2.8-4	SL4	2.8	3.0	2.8	5.5	8.5	15	21	1.0	3	

Note 1: Device measured between pin 1 to 2, pin 3 to 4, pin 5 to 6 and pin 7 to 8.

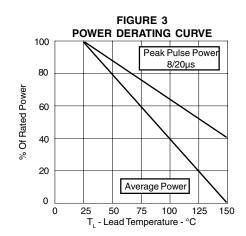
# **SLVU2.8-4**

## GRAPHS





t - Time - µs



**FIGURE 4** Typical Clamping Voltage vs Peak Pulse Current 20 PIN 2 TO 1  $V_{c}$  - Clamping Voltage - V 16 12 8 PIN 3 TO 1 4 0 Ó0 5 10 15 20 25 30 I<sub>PP</sub> - Peak Pulse Current A

# APPLICATION NOTE

Electronic equipment is susceptible to damage caused by Electrostatic Discharge (ESD), Electrical Fast Transients (EFT), and tertiary lightning effects. Knowing that equipment can be damaged, the SLVU2.8-4 was designed to provide the level of protection required to safe guard sensitive equipment. This product can be used in different configurations to provide a level of protection to meet unidirectional line requirements as well as bidirectional requirements either in a common-mode or differential-mode configuration.

#### UNIDIRECTIONAL DIFFERENTIAL-MODE CONFIGURATION (Figure 1)

The SLVU2.8-4 provides up to four lines of protection in a differential-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pin 1
- ✔ Line 2 is connected to Pin 7
- ✓ Line 3 is connected to Pin 3
- ✓ Line 4 is connected to Pin 5
- ✓ Pins 2, 4, 7 and 8 are connected to ground

#### **BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 2)**

The SLVU2.8-4 provides up to two lines of protection in a common-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pins 1 & 8
- ✓ Line 2 is connected to Pins 4 & 5
- ✓ Pins 2, 3, 6, and 7 are connected to ground

#### **BIDIRECTIONAL DIFFERENTIAL-MODE CONFIGURATION (Figure 3)**

The SLVU2.8-4 provides up to two-line pairs of protection in a differential-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

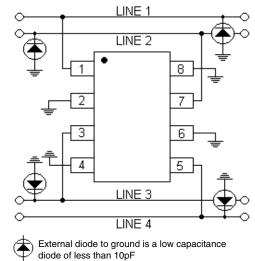
- ✓ Line Pair 1 is connected to Pins 1 & 2
- ✔ Line Pair 1 is connected to Pins 7 & 8
- ✓ Line Pair 2 is connected to Pins 3 & 4
- ✓ Line Pair 2 is connected to Pins 5 & 6

#### **CIRCUIT BOARD LAYOUT RECOMMENDATIONS**

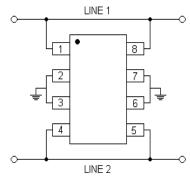
Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

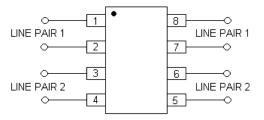




#### Figure 2. Bidirectional Common-Mode Protection

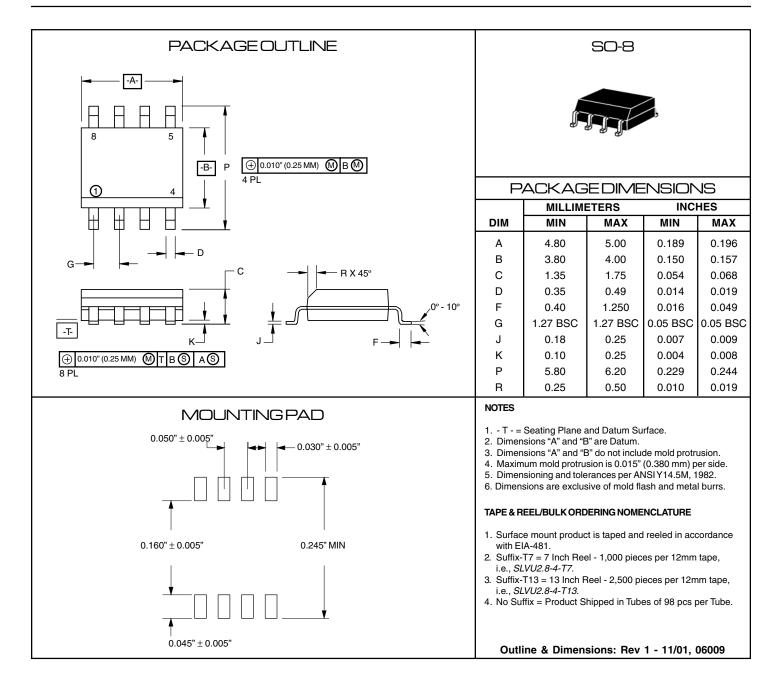


#### Figure 3. Bidirectional Differential-Mode Protection



# **SLVU2.8-4**

# PACKAGE OUTLINE & DIMENSIONS



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#### ProTek Devices

2929 South Fair Lane, Tempe, AZ 85282 Tel: 602-431-8101 Fax: 602-431-2288 E-Mail: <u>sales@protekdevices.com</u> Web Site: <u>www.protekdevices.com</u>